4V Drive Nch+Pch MOSFET

SH8M2

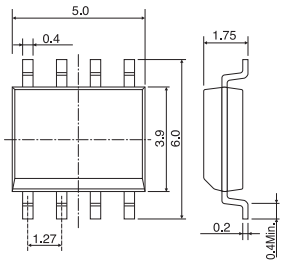
●Structure
Silicon N-channel / P-channel MOSFET

●Features
1) Low on-resistance.
2) Built-in G-S protection diode.
3) Small surface mount package (SOP8).

●Application
Power switching, DC / DC converter.

●Dimensions (Unit : mm)

SOP8

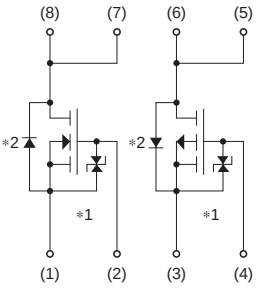


Each lead has same dimensions

●Packaging specifications

Type	Package	Taping
	Code	TB
	Basic ordering unit (pieces)	2500
SH8M2		◯

●Inner circuit



(1) Tr1 Source
(2) Tr1 Gate
(3) Tr2 Source
(4) Tr2 Gate
(5) Tr2 Drain
(6) Tr2 Drain
(7) Tr1 Drain
(8) Tr1 Drain

∗1 ESD PROTECTION DIODE
∗2 BODY DIODE

●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits		Unit
			Tr1 : N-ch	Tr2 : P-ch	
Drain-source voltage		V_{DSS}	30	−30	V
Gate-source voltage		V_{GSS}	±20	±20	V
Drain current	Continuous	I_D	±3.5	±3.5	A
	Pulsed	I_{DP}∗1	±14	±14	A
Source current (Body diode)	Continuous	I_S	1.6	−1.6	A
	Pulsed	I_{SP}∗1	14	−14	A
Total power dissipation		P_D∗2	2.0		W / TOTAL
Channel temperature		Tch	150		°C
Storage temperature		Tstg	−55 to +150		°C

∗1 Pw≤10μs, Duty cycle≤1%
∗2 Mounted on a ceramic board.

N-ch

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	–	–	±10	μA	V_{GS}=±20V, V_{DS}=0V
Drain-source breakdown voltage	$V_{(BR)\ DSS}$	30	–	–	V	I_D= 1mA, V_{GS}=0V
Zero gate voltage drain current	I_{DSS}	–	–	1	μA	V_{DS}= 30V, V_{GS}=0V
Gate threshold voltage	$V_{GS\ (th)}$	1.0	–	2.5	V	V_{DS}= 10V, I_D= 1mA
Static drain-source on-state resistance	$R_{DS\ (on)}$*	–	59	83	mΩ	I_D= 3.5A, V_{GS}= 10V
		–	93	130	mΩ	I_D= 3.5A, V_{GS}= 4.5V
		–	107	150	mΩ	I_D= 3.5A, V_{GS}= 4V
Forward transfer admittance	$\|Y_{fs}\|$ *	2.0	–	–	S	V_{DS}= 10V, I_D= 3.5A
Input capacitance	C_{iss}	–	140	–	pF	V_{DS}= 10V
Output capacitance	C_{oss}	–	45	–	pF	V_{GS}=0V
Reverse transfer capacitance	C_{rss}	–	30	–	pF	f=1MHz
Turn-on delay time	$t_{d\ (on)}$ *	–	6	–	ns	V_{DD}≒ 15V I_D= 1.75A V_{GS}= 10V R_L= 8.57Ω R_G=10Ω
Rise time	t_r *	–	6	–	ns	
Turn-off delay time	$t_{d\ (off)}$ *	–	17	–	ns	
Fall time	t_f *	–	4	–	ns	
Total gate charge	Q_g *	–	2.5	3.5	nC	V_{DD}≒ 15V, V_{GS}= 5V
Gate-source charge	Q_{gs} *	–	0.8	–	nC	I_D= 3.5A
Gate-drain charge	Q_{gd} *	–	0.8	–	nC	R_L= 4.29Ω, R_G= 10Ω

*Pulsed

●Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD}*	–	–	1.2	V	I_S= 6.4A, V_{GS}=0V

*Pulsed

P-ch

●**Electrical characteristics** (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	–	–	±10	μA	V_{GS}= ±20V, V_{DS}=0V
Drain-source breakdown voltage	$V_{(BR)\ DSS}$	–30	–	–	V	I_D= –1mA, V_{GS}=0V
Zero gate voltage drain current	I_{DSS}	–	–	–1	μA	V_{DS}= –30V, V_{GS}=0V
Gate threshold voltage	$V_{GS\ (th)}$	–1.0	–	–2.5	V	V_{DS}= –10V, I_D= –1mA
Static drain-source on-state resistance	$R_{DS\ (on)}$*	–	65	90	mΩ	I_D= –3.5A, V_{GS}= –10V
		–	100	140	mΩ	I_D= –1.75A, V_{GS}= –4.5V
		–	120	165	mΩ	I_D= –1.75A, V_{GS}= –4V
Forward transfer admittance	$\|Y_{fs}\|$ *	1.8	–	–	S	V_{DS}= –10V, I_D= –1.75A
Input capacitance	C_{iss}	–	490	–	pF	V_{DS}= –10V
Output capacitance	C_{oss}	–	110	–	pF	V_{GS}= 0V
Reverse transfer capacitance	C_{rss}	–	75	–	pF	f=1MHz
Turn-on delay time	$t_{d\ (on)}$ *	–	10	–	ns	V_{DD} ≒ –15V I_D= –1.75A V_{GS}= –10V R_L= 8.57Ω R_G= 10Ω
Rise time	t_r *	–	15	–	ns	
Turn-off delay time	$t_{d\ (off)}$ *	–	35	–	ns	
Fall time	t_f *	–	10	–	ns	
Total gate charge	Q_g *	–	5.5	7.7	nC	V_{DD} ≒ –15V, V_{GS}= –5V
Gate-source charge	Q_{gs} *	–	1.5	–	nC	I_D= –3.5A
Gate-drain charge	Q_{gd} *	–	2.0	–	nC	R_L= 4.29Ω, R_G= 10Ω

*Pulsed

●**Body diode characteristics** (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD}*	–	–	–1.2	V	I_S= –1.6A, V_{GS}=0V

*Pulsed

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